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Information technology — Open Trusted Technology ProviderTM Standard (O-TTPS) — Mitigating maliciously tainted and counterfeit products —

Part 1:

Requirements and recommendations

Technologies de l'information — Norme de fournisseur de technologie de confiance ouverte (O-TTPS) — Atténuation des produits contrefaits et malicieusement contaminés —

Partie 1: Exigences et recommandations



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FOREWORD

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